DATA SHEET



MOS FIELD EFFECT TRANSISTOR 2SK3295

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK3295 is N-Channel MOS FET device that features a low on-state resistance and excellent switching characteristics, designed for low voltage high current applications such as DC/DC converter with synchronous rectifier.

ORDERING INFORMATION

PART NUMBER	PACKAGE		
2SK3295	TO-220AB		
2SK3295-S	TO-262		
2SK3295-ZK	TO-263(MP-25ZK)		
2SK3295-ZJ	TO-263(MP-25ZJ)		

FEATURES

- 4.5 V drive available
- Low on-state resistance $R_{DS(on)1} = 18 \ m\Omega \ MAX. \ (V_{GS} = 10 \ V, \ I_D = 18 \ A)$
- Low gate charge
 Q_G = 16 nC TYP. (I_D = 35 A, V_{DD} = 16 V, V_{GS} = 10 V)
- Built-in gate protection diode
- Surface mount device available

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (V _{GS} = 0 V)	Vdss	20	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	ID(DC)	±35	А
Drain Current (Pulse) Note	D(pulse)	±140	А
Total Power Dissipation ($T_A = 25^{\circ}C$)	PT1	1.5	W
Total Power Dissipation (Tc = 25° C)	PT2	35	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Note DW/ < 40 - Duty Ousla < 40/			

Note PW \leq 10 μ s, Duty Cycle \leq 1%

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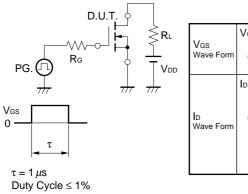
Document No. D14064EJ2V0DS00 (2nd edition) Date Published April 2001 NS CP(K) Printed in Japan The mark **★** shows major revised points.

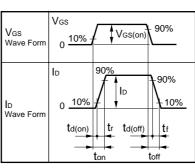
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ELECTRICAL CHARACTERISTICS(TA = 25°C)

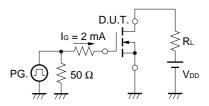
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	Vds = 20 V, Vgs = 0 V			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	Vds = 10 V, ld = 1 mA	1.0		2.5	V
Forward Transfer Admittance	y _{fs}	Vds = 10 V, Id = 18 A	7.5			S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, I⊳ = 18 A		13	18	mΩ
	RDS(on)2	Vgs = 4.5 V, I⊵ = 18 A		21	27	mΩ
Input Capacitance	Ciss	Vds = 10 V		720		pF
Output Capacitance	Coss	Vgs = 0 V		370		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		180		pF
Turn-on Delay Time	td(on)	$V_{DD} = 10 \text{ V}$, $I_{D} = 18 \text{ A}$		85		ns
Rise Time	tr	VGS(on) = 10 V		2000		ns
Turn-off Delay Time	td(off)	R _G = 10 Ω		65		ns
Fall Time	tr			270		ns
Total Gate Charge	QG	Vdd = 16 V		16		nC
Gate to Source Charge	QGS	Vgs = 10 V		3.1		nC
Gate to Drain Charge	Qgd	ID = 35 A		5.2		nC
Body Diode Forward Voltage	VF(S-D)	IF = 35 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 35 A, VGS = 0 V		28		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		14		nC

TEST CIRCUIT 1 SWITCHING TIME



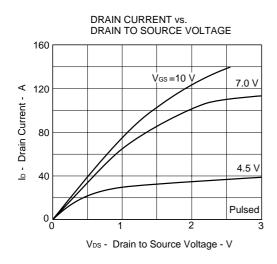


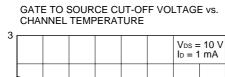
TEST CIRCUIT 2 GATE CHARGE

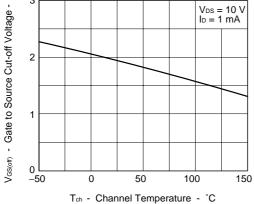


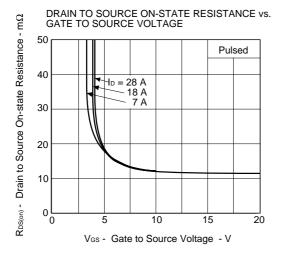
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TYPICAL CHARACTERISTICS (TA = 25°C)

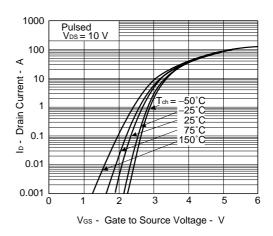




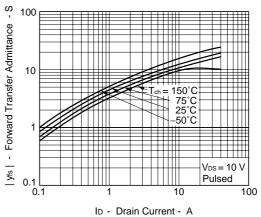


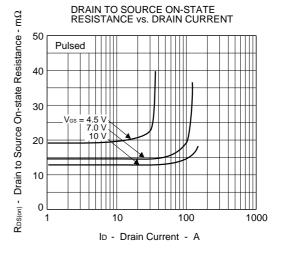


FORWARD TRANSFER CHARACTERISTICS



FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT





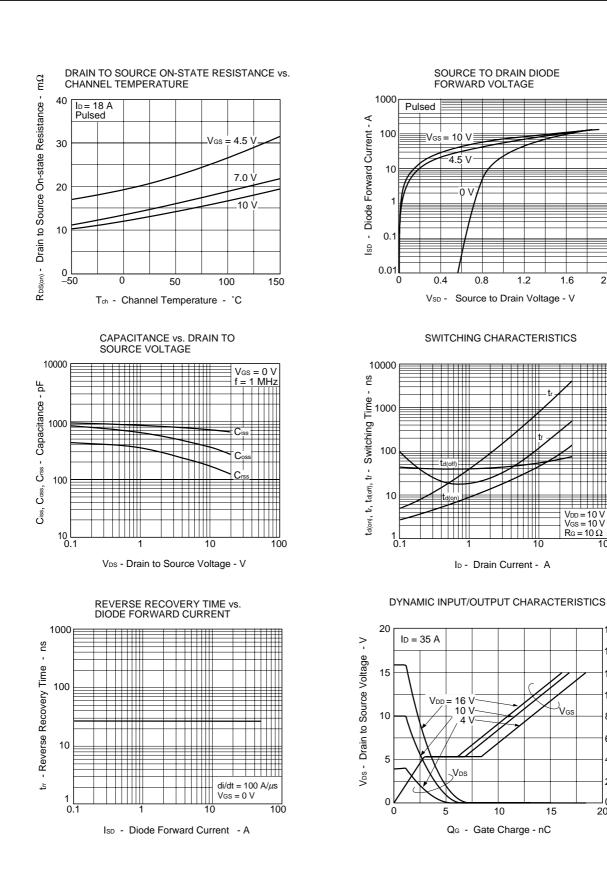
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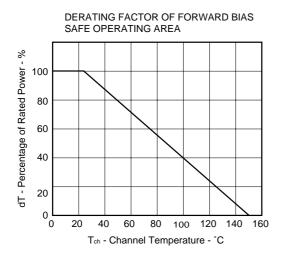
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Gate to Source Voltage -

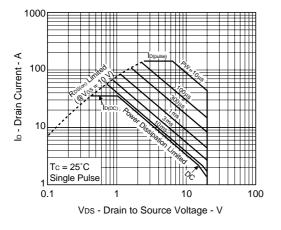
V_{GS}

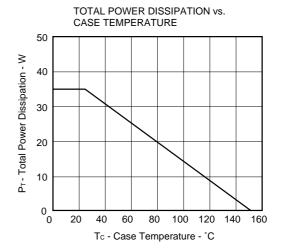


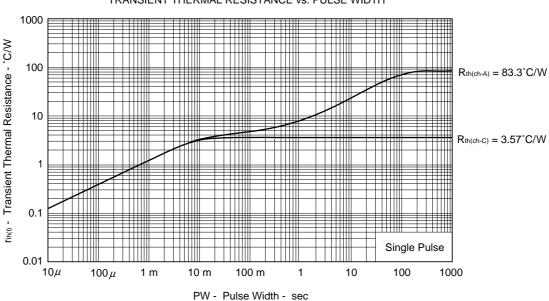
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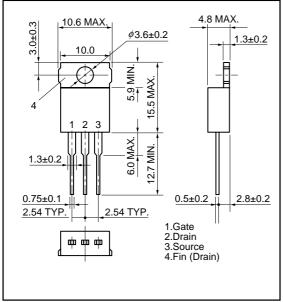


TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

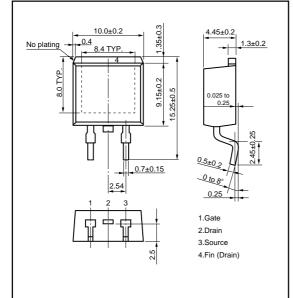
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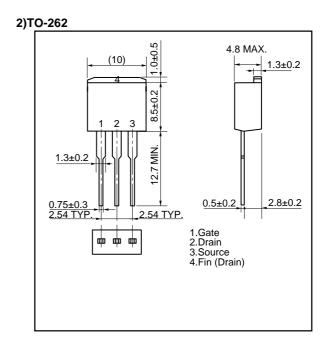
PACKAGE DRAWINGS (Unit : mm)

1)TO-220AB (MP-25)

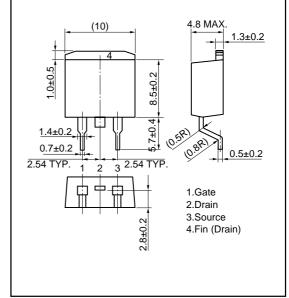


3)TO-263 (MP-25ZK)

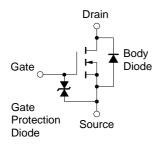








EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD.

When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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[MEMO]

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